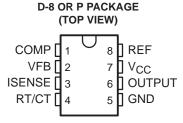
- Optimized for Off-Line and dc-to-dc Converters
- Low Start-Up Current (<1 mA)</li>
- Automatic Feed-Forward Compensation
- Pulse-by-Pulse Current Limiting
- Enhanced Load-Response Characteristics
- Undervoltage Lockout With Hysteresis
- Double-Pulse Suppression
- High-Current Totem-Pole Output
- Internally Trimmed Bandgap Reference
- 500-kHz Operation
- Error Amplifier With Low Output Resistance
- Designed to Be Interchangeable With UC2842 and UC3842 Series

#### **D PACKAGE** (TOP VIEW) COMP $\mathsf{\Pi}\,\mathsf{REF}$ 14 □ NC NC 2 13 VFB 13 12 V<sub>CC</sub> 11 VC NC 4 ISENSE [] 5 10 NC 6 9 **[**] GND RT/CT 8 POWER GROUND

NC - No internal connection



# description

The TL284x and TL384x series of control integrated circuits provide the features that are

necessary to implement off-line or dc-to-dc fixed-frequency current-mode control schemes with a minimum number of external components. Some of the internally implemented circuits are an undervoltage lockout (UVLO), featuring a start-up current of less than 1 mA, and a precision reference trimmed for accuracy at the error amplifier input. Other internal circuits include logic to ensure latched operation, a pulse-width modulation (PWM) comparator (which also provides current-limit control), and a totem-pole output stage designed to source or sink high-peak current. The output stage, suitable for driving N-channel MOSFETs, is low when it is in the off state.

Major differences between members of these series are the UVLO thresholds and maximum duty-cycle ranges. Typical UVLO thresholds of 16 V (on) and 10 V (off) on the TLx842 and TLx844 devices make them ideally suited to off-line applications. The corresponding typical thresholds for the TLx843 and TLx845 devices are 8.4 V (on) and 7.6 V (off). The TLx842 and TLx843 devices can operate to duty cycles approaching 100%. A duty-cycle range of 0 to 50% is obtained by the TLx844 and TLx845 by the addition of an internal toggle flip-flop, which blanks the output off every other clock cycle.

The TL284x-series devices are characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C. The TL384x-series devices are characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

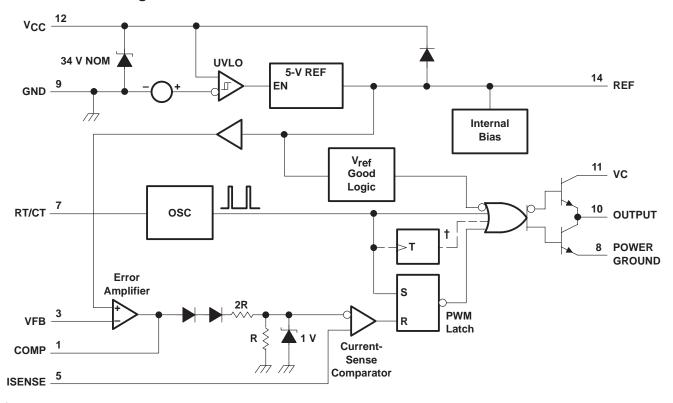


### **AVAILABLE OPTIONS**

	PA	CKAGED DEVICES		CHIP FORM
TA	SMALL OUTLINE (D)	SMALL OUTLINE (D-8)	PLASTIC DIP (P)	(Y)
0°C to 70°C	TL3842D TL3843D TL3844D TL3845D	TL3842D-8 TL3843D-8 TL3844D-8 TL3845D-8	TL3842P TL3843P TL3844P TL3845P	TL3842Y TL3843Y TL3844Y TL3845Y
-40°C to 85°C	TL2842D TL2843D TL2844D TL2845D	TL2842D-8 TL2843D-8 TL2844D-8 TL2845D-8	TL2842P TL2843P TL2844P TL2845P	

The D and D-8 packages are available taped and reeled. Add the suffix R to the device type (i.e., TL3842DR or TL3842DR-8). Chip forms are tested at 25°C.

## functional block diagram



<sup>†</sup> The toggle flip-flop is present only in TL2844, TL2845, TL3844, and TL3845. Pin numbers shown are for the D Package.



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage (see Note 1) (I <sub>CC</sub> < 30 mA)	Self limiting
Analog input voltage range, V <sub>I</sub> (VFB and ISENSE)	
Output voltage, VO (OUTPUT)	35 V
Input voltage, V <sub>I</sub> , (VC, D package only)	35 V
Supply current, I <sub>CC</sub>	30 mA
Output current, IO	±1 A
Error amplifier output sink current	10 mA
Package thermal impedance, $\theta_{JA}$ (see Notes 2 and 3): D package	ge 86°C/W
D-8 pac	kage 97°C/W
P packa	ge 85°C/W
Virtual junction temperature range, T <sub>J</sub>	0°C to 150°C
Output energy (capacitive load)	
Lead temperature, 1,6 mm (1/16 inch) from case for 10 seconds	3 260°C
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C
<del>9</del>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages are with respect to the device GND terminal.
  - 2. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability.
  - 3. The package thermal impedance is calculated in accordance with JESD 51.

# recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub> and VC <sup>‡</sup>				30	V
Input voltage, V <sub>I</sub> , RT/CT		0		5.5	V
Input voltage, V <sub>I</sub> , VFB and ISENSE		0		5.5	V
Output voltage, VO, OUTPUT		0		30	V
Output voltage, V <sub>O</sub> , POWER GROUND <sup>‡</sup>		-0.1		1	V
Supply current, externally limited, I <sub>CC</sub>				25	mA
Average output current, IO				200	mA
Reference output current, I <sub>O(ref)</sub>				-20	mA
Oscillator frequency, f <sub>OSC</sub>			100	500	kHz
Operating virtual junction temperature, T <sub>J</sub>		0		125	°C
On continue force sinteres continue T	TL284x	-40		85	° <b>°</b>
Operating free-air temperature, T <sub>A</sub>	TL384x	0		70	ç

<sup>‡</sup> These recommended voltages for V<sub>C</sub> and POWER GROUND apply only to the D package.



electrical characteristics over recommended operating free-air temperature range,  $V_{CC}$  = 15 V (see Note 4),  $R_T$  = 10 k $\Omega$ ,  $C_T$  = 3.3 nF (unless otherwise specified)

### reference section

DADAMETED	TEST OF	NDITIONS		TL284x			TL384x		LINIT
PARAMETER	1551 CC	NDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNIT
Output voltage	$I_O = 1 \text{ mA},$	T <sub>A</sub> = 25°C	4.95	5	5.05	4.9	5	5.1	V
Line regulation	V <sub>CC</sub> = 12 V to 25 V			6	20		6	20	mV
Load regulation	$I_O = 1 \text{ mA to } 20 \text{ mA}$			6	25		6	25	mV
Temperature coefficient of output voltage				0.2	0.4		0.2	0.4	mV/°C
Output voltage with worst-case variation	$V_{CC} = 12 \text{ V to } 25 \text{ V},$	I <sub>O</sub> = 1 mA to 20 mA	4.9		5.1	4.82		5.18	V
Output noise voltage	f = 10 Hz to 10 kHz,	T <sub>A</sub> = 25°C		50			50		μV
Output-voltage long-term drift	After 1000 h at T <sub>A</sub> = 2	25°C		5	25		5	25	mV
Short-circuit output current		_	-30	-100	-180	-30	-100	-180	mA

<sup>&</sup>lt;sup>†</sup> All typical values are at  $T_A = 25$ °C.

NOTE 4: Adjust VCC above the start threshold before setting it to 15 V.

### oscillator section

PARAMETER	TEST CONDITIONS	TL284x			TL384x			UNIT
PARAMETER	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNII
Oscillator frequency (see Note 5)	T <sub>A</sub> = 25°C	47	52	57	47	52	57	kHz
Frequency change with supply voltage	V <sub>CC</sub> = 12 V to 25 V		2	10		2	10	Hz/kHz
Frequency change with temperature			50			50		Hz/kHz
Peak-to-peak amplitude at RT/CT			1.7			1.7		V

<sup>†</sup> All typical values are at  $T_A = 25$ °C.

NOTES: 4. Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.

5. Output frequency equals oscillator frequency for the TLx842 and TLx843. Output frequency is one-half oscillator frequency for the TLx844 and TLx845.

### error-amplifier section

PARAMETER	7507	CONDITIONS		TL284x			TL384x		UNIT
PARAMETER	1531	CONDITIONS	MIN	TYP <sup>†</sup>	MAX	MIN	TYP <sup>†</sup>	MAX	UNIT
Feedback input voltage	COMP at 2.5 V		2.45	2.50	2.55	2.42	2.50	2.58	V
Input bias current				-0.3	-1		-0.3	-2	μΑ
Open-loop voltage amplification	V <sub>O</sub> = 2 V to 4 V		65	90		65	90		dB
Gain-bandwidth product			0.7	1		0.7	1		MHz
Supply-voltage rejection ratio	$V_{CC} = 12 \text{ V to } 2$	25 V	60	70		60	70		dB
Output sink current	VFB at 2.7 V,	COMP at 1.1 V	2	6		2	6		mA
Output source current	VFB at 2.3 V,	COMP at 5 V	-0.5	-0.8		-0.5	-0.8		mA
High-level output voltage	VFB at 2.3 V,	$R_L = 15 \text{ k}\Omega \text{ to GND}$	5	6		5	6		V
Low-level output voltage	VFB at 2.7 V,	$R_L = 15 \text{ k}\Omega \text{ to GND}$		0.7	1.1		0.7	1.1	V

<sup>&</sup>lt;sup>†</sup> All typical values are at  $T_A = 25$ °C.

NOTE 4: Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.



electrical characteristics over recommended operating free-air temperature range,  $V_{CC}$  = 15 V (see Note 4),  $R_T$  = 10 k $\Omega$ ,  $C_T$  = 3.3 nF (unless otherwise specified) (continued)

### current-sense section

PARAMETER	TEST COND	TEST CONDITIONS		TL284x			TL384x			
PARAMETER			MIN	TYP <sup>†</sup>	MAX	UNIT				
Voltage amplification	See Notes 6 and 7		2.85	3	3.13	2.85	3	3.15	V/V	
Current-sense comparator threshold	COMP at 5 V,	See Note 6	0.9	1	1.1	0.9	1	1.1	V	
Supply-voltage rejection ratio	$V_{CC} = 12 \text{ V to } 25 \text{ V},$	See Note 6		70			70		dB	
Input bias current				-2	-10		-2	-10	μΑ	
Delay time to output				150	300		150	300	ns	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $T_A = 25$ °C.

NOTES: 4. Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

- 6. These parameters are measured at the trip point of the latch, with VFB at 0 V.
- 7. Voltage amplification is measured between ISENSE and COMP, with the input changing from 0 V to 0.8 V.

### output section

PARAMETER	TEST CONDITIONS	TL284x			TL384x			UNIT
PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT
High-level output voltage	I <sub>OH</sub> = -20 mA	13	13.5		13	13.5		V
l light-level output voltage	I <sub>OH</sub> = -200 mA	12	13.5		12	13.5		V
Low-level output voltage	I <sub>OL</sub> = 20 mA		0.1	0.4		0.1	0.4	V
Low-level output voltage	I <sub>OL</sub> = 200 mA		1.5	2.2		1.5	2.2	V
Rise time	$C_L = 1 \text{ nF}, \qquad T_A = 25^{\circ}C$		50	150		50	150	ns
Fall time	$C_L = 1 \text{ nF}, \qquad T_A = 25^{\circ}\text{C}$		50	150		50	150	ns

<sup>&</sup>lt;sup>†</sup> All typical values are at  $T_A = 25$ °C.

NOTE 4: Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.

### undervoltage-lockout section

PARAMETER		TL284x				UNIT		
		MIN	TYP	MAX	MIN	TYP <sup>†</sup>	MAX	UNII
Start throughold voltage	TLx842, TLx844	15	16	17	14.5	16	17.5	V
Start threshold voltage	TLx843, TLx845	7.8	8.4	9	7.8	8.4	9	V
Minimum energing voltage ofter startur	TLx842, TLx844	9	10	11	8.5	10	11.5	V
Minimum operating voltage after startup	TLx843, TLx845	7	7.6	8.2	7	7.6	8.2	V

 $<sup>\</sup>overline{\dagger}$  All typical values are at  $T_A = 25$ °C.

NOTE 4: Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.

### pulse-width-modulator section

PARAMETER -		TL284x				UNIT		
		MIN	TYP <sup>†</sup>	MAX	MIN	TYP†	MAX	UNII
Mariana	TLx842, TLx843	95%	97%	100%	95%	97%	100%	
Maximum duty cycle	TLx844, TLx845	46%	48%	50%	46%	48%	50%	
Minimum duty cycle				0			0	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $T_A = 25$ °C.

NOTE 4: Adjust  $V_{\hbox{CC}}$  above the start threshold before setting it to 15 V.



electrical characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 15 V (see Note 4),  $R_T = 10 \text{ k}\Omega$ ,  $C_T = 3.3 \text{ nF}$  (unless otherwise specified) (continued)

### supply voltage

PARAMETER	TEST CONDITIONS		TL284x			TL384x		
PARAMETER			TYP†	MAX	MIN	TYP†	MAX	UNIT
Start-up current			0.5	1		0.5	1	mA
Operating supply current	VFB and ISENSE at 0 V		11	17		11	17	mA
Limiting voltage	I <sub>CC</sub> = 25 mA		34			34		V

† All typical values are at  $T_A = 25^{\circ}$ C. NOTE 4: Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

# electrical characteristics, $V_{CC}$ = 15 V (see Note 4), $R_T$ = 10 k $\Omega$ , $C_T$ = 3.3 nF, $T_A$ = 25°C (unless otherwise specified)

### reference section

DADAMETED	PARAMETER TEST CONDITIONS					
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Output voltage	I <sub>O</sub> = 1 mA		5		V	
Line regulation	V <sub>CC</sub> = 12 V to 25 V		6		mV	
Load regulation	I <sub>O</sub> = 1 mA to 20 mA		6		mV	
Temperature coefficient of output voltage			0.2		mV/°C	
Output noise voltage	f = 10 Hz to 10 kHz		50		μV	
Output-voltage long-term drift	After 1000 h at T <sub>A</sub> = 25°C		5		mV	
Short-circuit output current			-100		mA	

NOTE 4: Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

### oscillator section

PARAMETER	TEST CONDITIONS	Т	UNIT		
		MIN	TYP	MAX	ONII
Oscillator frequency (see Note 5)			52		kHz
Frequency change with supply voltage	V <sub>CC</sub> = 12 V to 25 V		2		Hz/kHz
Frequency change with temperature			5		Hz/kHz
Peak-to-peak amplitude at RT/CT			1.7		V

NOTES: 4. Adjust  $V_{\hbox{CC}}$  above the start threshold before setting it to 15 V.

5. Output frequency equals oscillator frequency for the TLx842 and TLx843. Output frequency is one-half oscillator frequency for the TLx844 and TLx845.



# electrical characteristics, $V_{CC}$ = 15 V (see Note 4), $R_T$ = 10 k $\Omega$ , $C_T$ = 3.3 nF, $T_A$ = 25°C (unless otherwise specified) (continued)

### error-amplifier section

PARAMETER	TEG	TEST CONDITIONS		TL384xY			
PARAMETER	IES			TYP	MAX	UNIT	
Feedback input voltage	COMP at 2.5 V			2.50		V	
Input bias current				-0.3		μА	
Open-loop voltage amplification	V <sub>O</sub> = 2 V to 4 V			90		dB	
Gain-bandwidth product				1		MHz	
Supply-voltage rejection ratio	V <sub>CC</sub> = 12 V to 25	V		70		dB	
Output sink current	VFB at 2.7 V,	COMP at 1.1 V		6		mA	
Output source current	VFB at 2.3 V,	COMP at 5 V		-0.8		mA	
High-level output voltage	VFB at 2.3 V,	$R_L = 15 \text{ k}\Omega \text{ to GND}$		6		V	
Low-level output voltage	VFB at 2.7 V,	$R_L = 15 \text{ k}\Omega \text{ to GND}$		0.7		V	

NOTE 4: Adjust  $V_{\hbox{\footnotesize CC}}$  above the start threshold before setting it to 15 V.

### current-sense section

PARAMETER	TEST CONDITIONS		Т	UNIT		
PARAMETER	1231 001	MIN	TYP	MAX	ONIT	
Voltage amplification	See Notes 6 and 7			3		V/V
Current-sense comparator threshold	COMP at 5 V,	See Note 6		1		V
Supply-voltage rejection ratio	$V_{CC} = 12 \text{ V to } 25 \text{ V},$	See Note 6		70		dB
Input bias current				-2		μΑ
Delay time to output				150		ns

NOTES: 4. Adjust  $V_{\hbox{CC}}$  above the start threshold before setting it to 15 V.

6. These parameters are measured at the trip point of the latch, with VFB at 0  $\rm V.$ 

7. Voltage amplification is measured between ISENSE and COMP, with the input changing from 0 V to 0.8 V.

### output section

PARAMETER	TEST CONDITIONS	Т	UNIT		
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
High level cutnut veltage	$I_{OH} = -20 \text{ mA}$	13.5			V
High-level output voltage	I <sub>OH</sub> = -200 mA		13.5		V
Low lovel output voltage	I <sub>OL</sub> = 20 mA		0.1		V
Low-level output voltage	I <sub>OL</sub> = 200 mA		1.5		V
Rise time	C <sub>L</sub> = 1 nF	50		ns	
Fall time	C <sub>L</sub> = 1 nF		50		ns

NOTE 4: Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

### undervoltage-lockout section

PARAMETER		TL384xY			UNIT
		MIN	TYP	MAX	UNII
Start threshold voltage	TL3842Y, TL3844Y		16		V
	TL3843Y, TL3845Y		8.4		V
Minimum operating voltage after startup	TL3842Y, TL3844Y		10		V
	TL3843Y, TL3845Y		7.6		V

NOTE 4: Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.



# TL284x, TL384x CURRENT-MODE PWM CONTROLLERS

SLVS038E - JANUARY 1989 - REVISED DECEMBER 1999

# electrical characteristics, $V_{CC}$ = 15 V (see Note 4), $R_T$ = 10 k $\Omega$ , $C_T$ = 3.3 nF, $T_A$ = 25°C (unless otherwise specified) (continued)

### pulse-width-modulator section

PARAMETER -		Т	UNIT		
		MIN	TYP	MAX	UNIT
Maximum duty avala	TL3842Y, TL3843Y		97%		
Maximum duty cycle	TL3844Y, TL3845Y		48%		

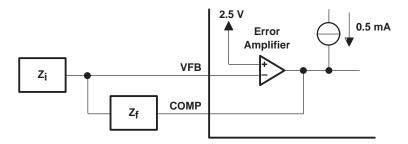
NOTE 4: Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.

## supply voltage

PARAMETER	TEST CONDITIONS	TL384xY			UNIT
FARAIVETER	TEST CONDITIONS	MIN	TYP	MAX	ONII
Start-up current			0.5	1	mA
Operating supply current	VFB and ISENSE at 0 V		11	17	mA
Limiting voltage	I <sub>CC</sub> = 25 mA		34		V

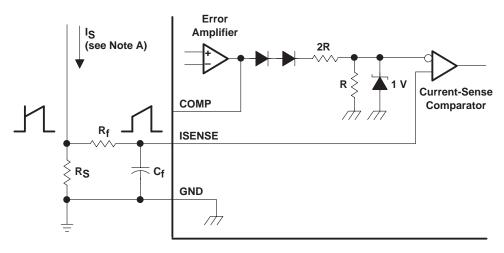
NOTE 4: Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.

### **APPLICATION INFORMATION**



NOTE A: Error amplifier can source or sink up to 0.5 mA.

Figure 1. Error-Amplifier Configuration

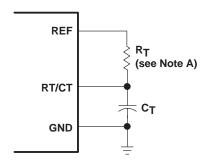


NOTE A: Peak current (Is) is determined by the formula:

$$I_{S(max)} = \frac{1 \text{ V}}{R_S}$$

 $I_{S(max)} = \frac{1\ V}{R_S}$  A small RC filter formed by resistor R<sub>f</sub> and capacitor C<sub>f</sub> may be required to suppress switch transients.

Figure 2. Current-Sense Circuit

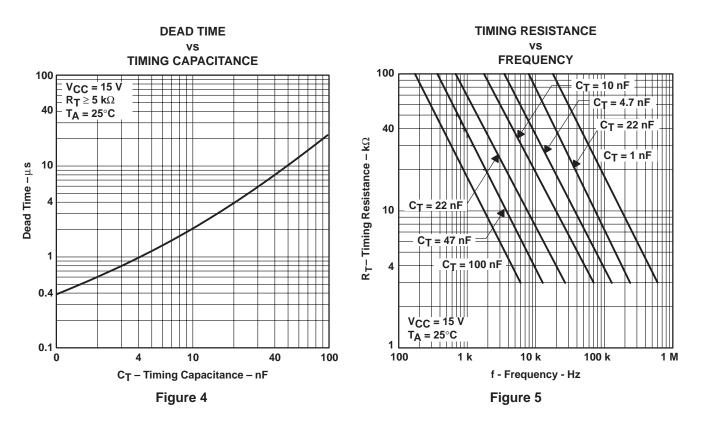


NOTE A: For RT > 5 k\Omega:  $f \approx \frac{1.72}{R_T C_T}$ 

Figure 3. Oscillator Section



### **APPLICATION INFORMATION**



## open-loop laboratory test fixture

In the open-loop laboratory test fixture shown in Figure 6, high peak currents associated with loads necessitate careful grounding techniques. Timing and bypass capacitors should be connected close to the GND terminal in a single-point ground. The transistor and  $5-k\Omega$  potentiometer sample the oscillator waveform and apply an adjustable ramp to the ISENSE terminal.

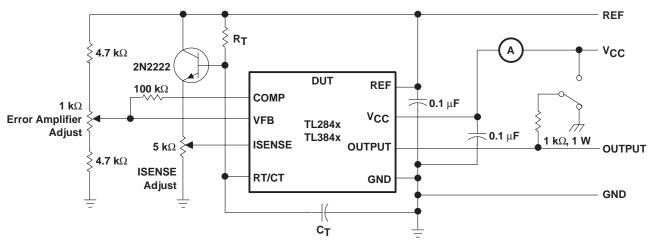


Figure 6. Open-Loop Laboratory Test Fixture



### **APPLICATION INFORMATION**

### shutdown technique

The PWM controller (see Figure 7) can be shut down by two methods: either raise the voltage at ISENSE above 1 V or pull the COMP terminal below a voltage two diode drops above ground. Either method causes the output of the PWM comparator to be high (refer to block diagram). The PWM latch is reset dominant so that the output remains low until the next clock cycle after the shutdown condition at the COMP or ISENSE terminal is removed. In one example, an externally latched shutdown can be accomplished by adding an SCR that resets by cycling  $V_{CC}$  below the lower UVLO threshold. At this point, the reference turns off, allowing the SCR to reset.

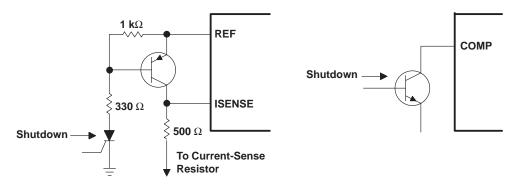


Figure 7. Shutdown Techniques

A fraction of the oscillator ramp can be resistively summed with the current-sense signal to provide slope compensation for converters requiring duty cycles over 50% (see Figure 8). Note that capacitor C forms a filter with R2 to suppress the leading-edge switch spikes.

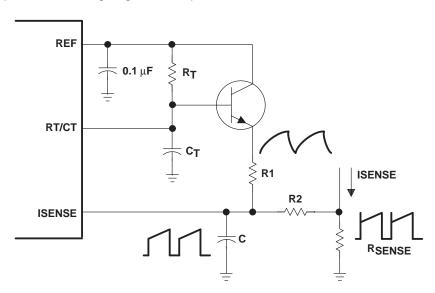


Figure 8. Slope Compensation

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